MRF5S19150R3 and MRF5S19150SR3 replaced by MRF5S19150HR3 and MRF5S19150HSR3. "H" suffix indicates lower thermal resistance package.

The RF MOSFET Line **RF Power Field Effect Transistors** N-Channel Enhancement-Mode Lateral MOSFETs

Designed for PCN and PCS base station applications at frequencies from 1.9 to 2.0 GHz. Suitable for TDMA, CDMA and multicarrier amplifier applications.

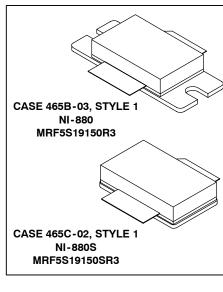
 Typical 2-Carrier N-CDMA Performance for V_{DD} = 28 Volts, P_{out} = 32 Watts, I_{DQ} = 1400 mA, f1 = 1958.75 MHz, f2 = 1961.25 MHz IS-95 CDMA (Pilot, Sync, Paging, Traffic Codes 8 Through 13)
 1.2288 MHz Channel Bandwidth Carrier. Adjacent Channels Measured over a 30 kHz Bandwidth at f1 -885 kHz and f2 +885 kHz. Distortion Products Measured over 1.2288 MHz Bandwidth at f1 -2.5 MHz and f2 +2.5 MHz. Peak/Avg. = 9.8 dB @ 0.01% Probability on CCDF. Output Power — 32 Watts Avg.

Power Gain — 14 dB Efficiency — 26% ACPR — -50 dB IM3 — -36.5 dBc

- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 28 Vdc, f1 = 1960 MHz, 100 Watts CW Output Power
- Excellent Thermal Stability
- Qualified Up to a Maximum of 32 V Operation
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.



1990 MHz, 32 W, 28 V LATERAL N-CHANNEL RF POWER MOSFETs



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	65	Vdc
Gate-Source Voltage	V _{GS}	-0.5, +15	Vdc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	357 2	Watts W/°C
Storage Temperature Range	T _{stg}	- 65 to +150	°C
Operating Junction Temperature	TJ	200	°C
CW Operation	CW	100	Watts

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value (1,2)	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$		°C/W
Case Temperature 80°C, 100 W CW		0.49	
Case Temperature 80°C, 32 W CW		0.53	

(1) MTTF calculator available at <u>http://www.motorola.com/semiconductors/rf</u>. Select Tools/Software/Application Software/Calculators to access the MTTF calculators by product.

(2) Refer to AN1955/D, Thermal Measurement Methodology of RF Power Amplifiers. Go to <u>http://www.motorola.com/semiconductors/rf</u>. Select Documentation/Application Notes - AN1955.

NOTE - **CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.



MOTOROLA

digitaldna

Test Conditions			Cla	SS	
Human Body Model			1 (Mini	mum)	
Machine Model Charge Device Model		M3 (Minimum) C7 (Minimum)			
Characteristic	, Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Zero Gate Voltage Drain Leakage Current (V _{DS} = 65 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	_	-	10	μAdc
Zero Gate Voltage Drain Leakage Current (V _{DS} = 28 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	_	_	1	μAdc
Gate-Source Leakage Current (V _{GS} = 5 Vdc, V _{DS} = 0 Vdc)	I _{GSS}		—	1	μAdc
ON CHARACTERISTICS					
Gate Threshold Voltage (V _{DS} = 10 Vdc, I _D = 360 μAdc)	V _{GS(th)}	2.5	2.8	3.5	Vdc
Gate Quiescent Voltage (V _{DS} = 28 Vdc, I _D = 1400 mAdc)	V _{GS(Q)}	_	3.8	_	Vdc
Drain-Source On-Voltage (V _{GS} = 10 Vdc, I _D = 3.6 Adc)	V _{DS(on)}	_	0.24	_	Vdc
Forward Transconductance (V _{DS} = 10 Vdc, I _D = 3.6 Adc)	9 _{fs}	—	9		S
OYNAMIC CHARACTERISTICS					
Reverse Transfer Capacitance (1) $(V_{DS} = 28 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$	C _{rss}	—	3.1	_	pF
UNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system) 2-Carrier Peak/Avg = 9.8 dB @ 0.01% Probability on CCDF.	N-CDMA, 1.2	288 MHz Cl	nannel Bandw	idth Carriers	
Common - Source Amplifier Power Gain (V_{DD} = 28 Vdc, P _{out} = 32 W Avg, I _{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	G _{ps}	13	14	_	dB
Drain Efficiency (V _{DD} = 28 Vdc, P _{out} = 32 W Avg, I _{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	η	24	26	_	%
Third Order Intermodulation Distortion (V_{DD} = 28 Vdc, P_{out} = 32 W Avg, I_{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz; IM3 measured over 1.2288 MHz Bandwidth at f1 -2.5 MHz and f2 +2.5 MHz referenced to carrier channel power.)	IM3		-36.5	-35	dBc
Adjacent Channel Power Ratio (V_{DD} = 28 Vdc, P _{out} = 32 W Avg, I _{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz; ACPR measured over 30 kHz Bandwidth at f1 - 885 MHz and f2 +885 MHz)	ACPR		-50	- 48	dBc
Input Return Loss (V _{DD} = 28 Vdc, P _{out} = 32 W Avg, I _{DQ} = 1400 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	IRL		-17	-9	dB

(1) Part is internally matched both on input and output.

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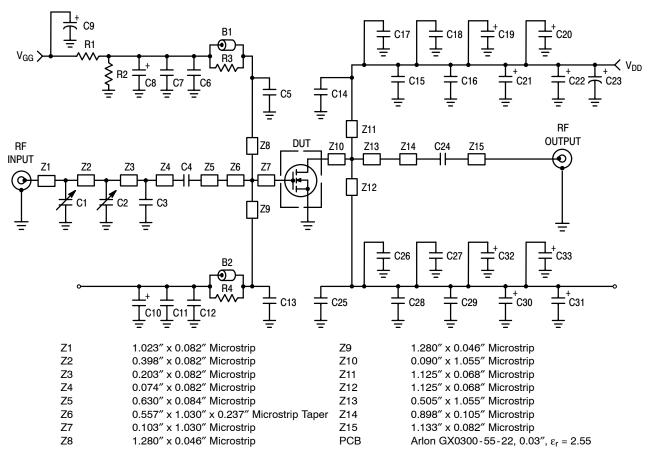


Figure 1. MRF5S19150 Test Circuit Schematic

Table 1. MRF5S19150 Test Circuit Component Designations and Values

Part	Description	
B1, B2	Short RF Beads	
C1, C2	0.6 - 4.5 Variable Capacitors, Gigatrim	
C3	0.8 pF Chip Capacitor, B Case	
C4, C5, C13, C14, C24, C25	9.1 pF Chip Capacitors, B Case	
C8, C10	1.0 µF, 50 V SMT Tantalum Capacitors	
C6, C12, C16, C17, C18, C27, C28, C29	0.1 µF Chip Capacitors, B Case	
C7, C11, C15, C26	1000 pF Chip Capacitors, B Case	
C9	100 μF, 50 V Electrolytic Capacitor	
C23	470 μF, 63 V Electrolytic Capacitor	
C19, C20, C21, C22, C30, C31, C32, C33	22 µF, 35 V Tantalum Capacitors	
R1	1 kΩ Chip Resistor	
R2	560 kΩ Chip Resistor	
R3, R4	12 Ω Chip Resistors	

3

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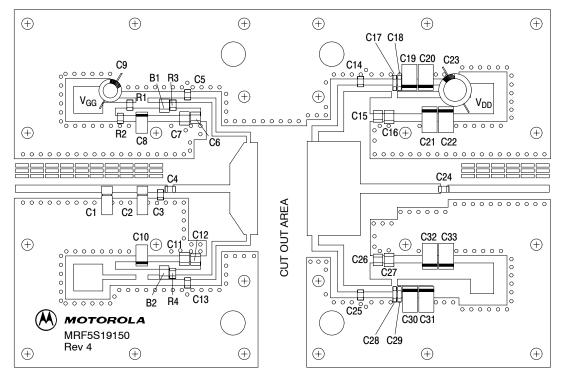
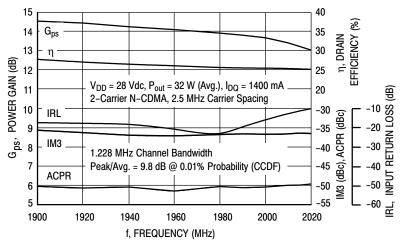


Figure 2. MRF5S19150 Test Circuit Component Layout

MOTOROLA RF DEVICE DATA

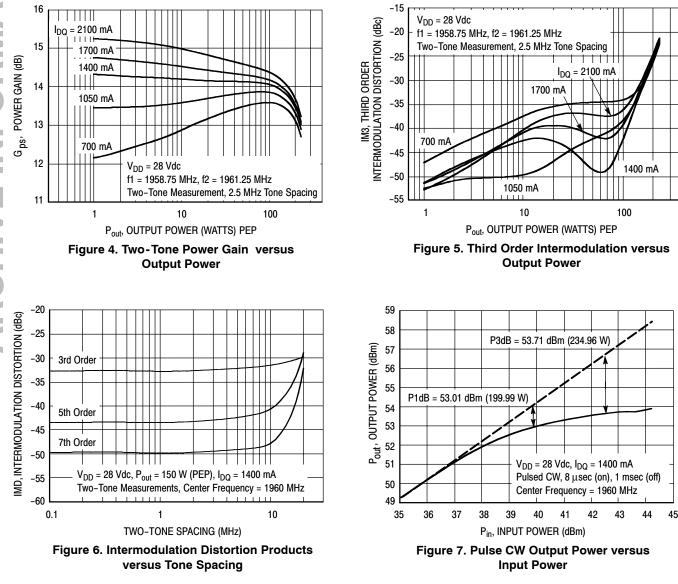
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TYPICAL CHARACTERISTICS



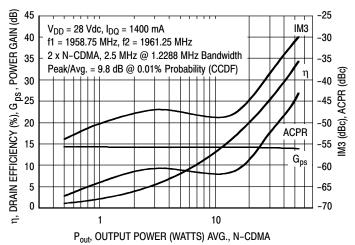


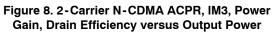


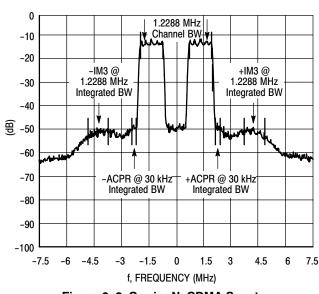


MRF5S19150R3 MRF5S19150SR3 ;, 5

TYPICAL CHARACTERISTICS

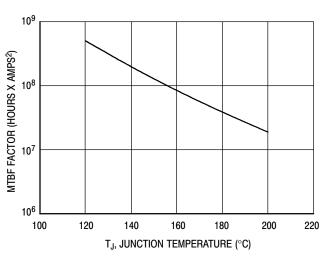






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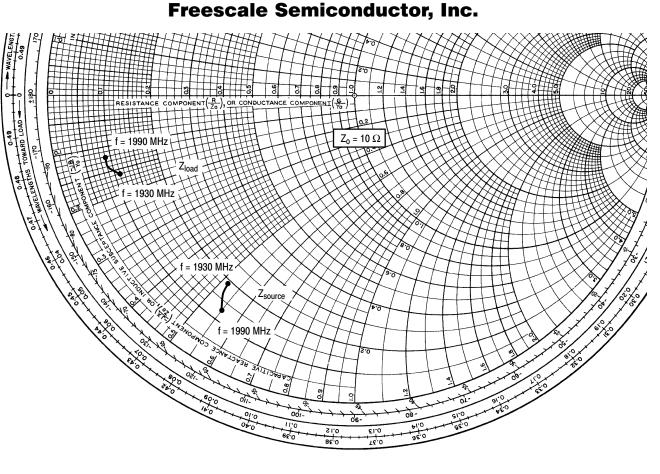




This above graph displays calculated MTBF in hours x ampere² drain current. Life tests at elevated temperatures have correlated to better than $\pm 10\%$ of the theoretical prediction for metal failure. Divide MTBF factor by I_D^2 for MTBF in a particular application.

Figure 10. MTBF Factor versus Junction Temperature

For More Information On This Product, Go to: www.freescale.com



 V_{DD} = 28 V, I_{DQ} = 1400 mA, P_{out} = 32 W Avg.

f MHz	Z_{source}	Z_{load}
1930	1.89 - j5.24	1.06 - j1.58
1960	1.64 - j5.29	0.88 - j1.37
1990	1.3 - j5.49	0.90 - j1.21

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

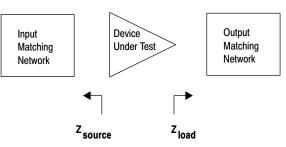
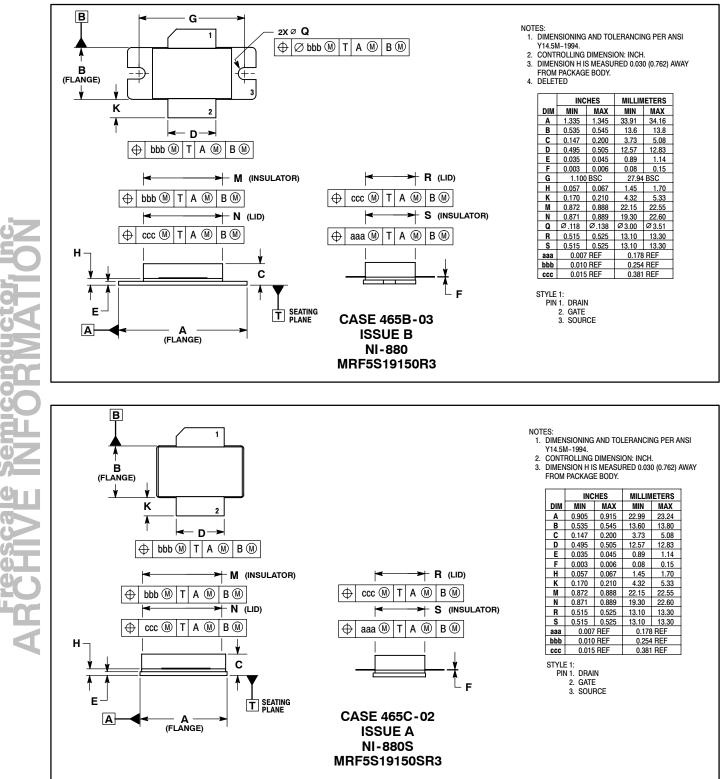


Figure 11. Series Equivalent Input and Output Impedance

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PACKAGE DIMENSIONS



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